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1. Name of conveying parties:	2. Name and	address of receiv	ving party:	
HUR, Myung-Koo	Norra Ott			
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Additional name(s) of conveying party(ies) attached?		onggi-do, Korea	onglong-gu, ouwo	11327 11/
🗌 Yes 🛛 No	Additional nar	ne(s) of receiving	party(ies) attached	÷ ۱
			Yes	No No
3. Nature of Conveyance:		<u> </u>		
Assignment Merger				
Security Agreement Change of Name				
Execution Date: June 12, 2006	-			
4. Application number(s) or patent number(s):	-			
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PATENT REEL: 018080 FRAME: 0214

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, <u>HUR, Myung-Koo</u> of <u>203-802 Jugong Green Vill 2-cha, Baeseok-dong, Cheonan-si,</u> <u>Chungcheongnam-do, Korea</u> hereby sell, assign and transfer to <u>SAMSUNG ELECTRONICS</u> <u>CO., LTD.</u> a corporation, having a place of business at <u>416, Maetan-dong, Yeongtong-gu,</u> <u>Suwon-si, Gyeonggi-do, Korea</u>, its successors and assigns, the entire right, title and interest throughout the world in our invention in

THIN FILM TRANSISTOR ARRAY PANEL AND METHOD FOR MANUFACTURING THE SAME

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this <u>12th</u> day of	June	, 2006.
	HUR. 1	MYUNG KOO
		HUR, Myung-Koo
WITNESSED: KIM Yu-Mi		
Signature for the me		
Date 12/06/2006		

Type or print name of witness

Assignment (Sole Inventor) At Filing-Witnessed

OPP 051492 US

PATENT REEL: 018080 FRAME: 0215

RECORDED: 07/03/2006